

SMALL SIGNAL NPN TRANSISTOR

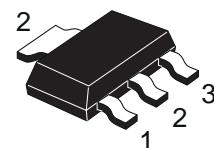
PRELIMINARY DATA

Type	Marking
PZT3904	3904

- SILICON EPITAXIAL PLANAR NPN TRANSISTOR
- SOT-223 PLASTIC PACKAGE FOR SURFACE MOUNTING CIRCUITS
- TAPE AND REEL PACKING
- THE PNP COMPLEMENTARY TYPE IS PZT3906

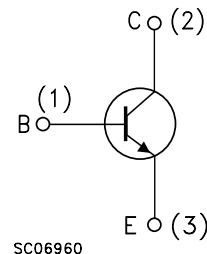
APPLICATIONS

- WELL SUITABLE FOR SMD MOTHER BOARD ASSEMBLY
- SMALL LOAD SWITCH TRANSISTOR WITH HIGH GAIN AND LOW SATURATION VOLTAGE



SOT-223

INTERNAL SCHEMATIC DIAGRAM



SC06960

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CBO}	Collector-Base Voltage ($I_E = 0$)	60	V
V_{CEO}	Collector-Emitter Voltage ($I_B = 0$)	40	V
V_{EBO}	Emitter-Base Voltage ($I_C = 0$)	6	V
I_C	Collector Current	200	mA
P_{tot}	Total Dissipation at $T_C = 25^\circ\text{C}$	1	W
T_{stg}	Storage Temperature	-65 to 150	$^\circ\text{C}$
T_j	Max. Operating Junction Temperature	150	$^\circ\text{C}$

PZT3904

THERMAL DATA

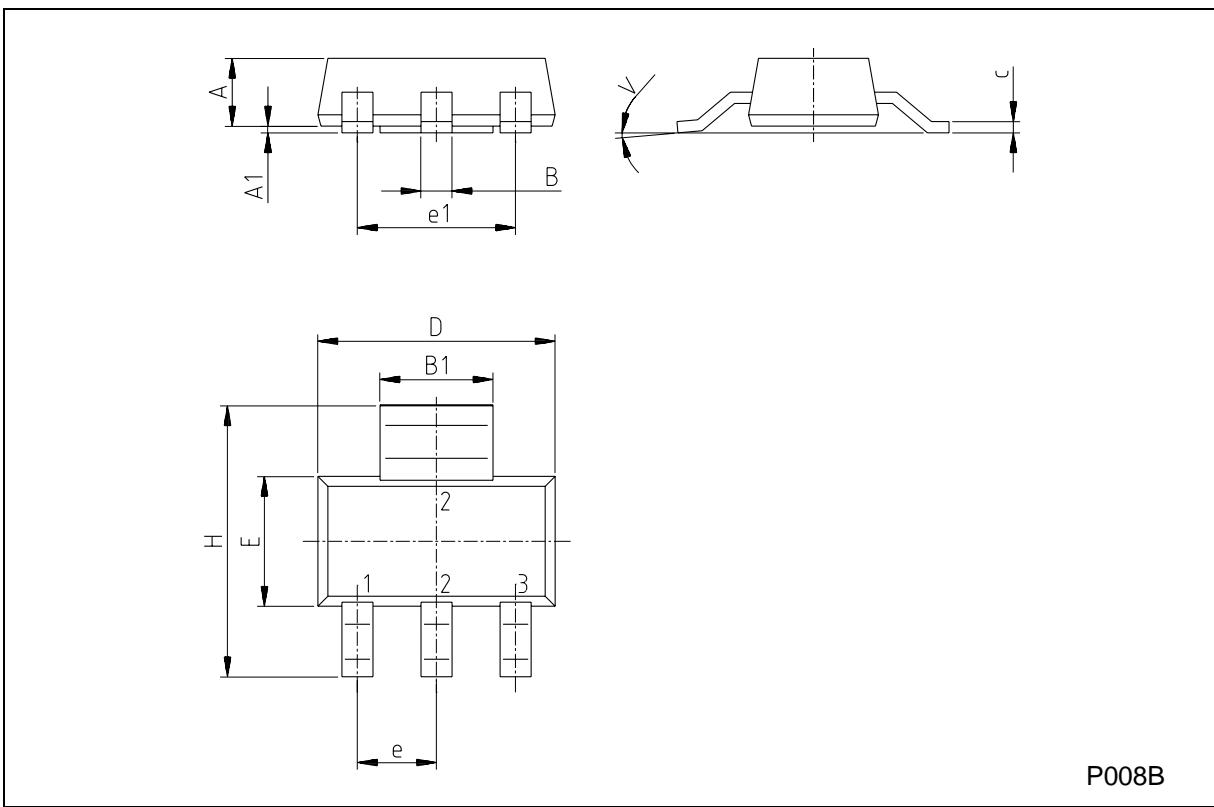
$R_{\text{thj-amb}}$ •	Thermal Resistance Junction-Ambient	Max	125	$^{\circ}\text{C/W}$
• Device mounted on a PCB area of 1 cm ²				

ELECTRICAL CHARACTERISTICS ($T_{\text{case}} = 25^{\circ}\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
I_{CEX}	Collector Cut-off Current ($V_{\text{BE}} = -3 \text{ V}$)	$V_{\text{CE}} = 30 \text{ V}$				50	nA
I_{BEX}	Base Cut-off Current ($V_{\text{BE}} = -3 \text{ V}$)	$V_{\text{CE}} = 30 \text{ V}$				50	nA
$V_{(\text{BR})\text{CEO}}^*$	Collector-Emitter Breakdown Voltage ($I_{\text{B}} = 0$)	$I_{\text{C}} = 1 \text{ mA}$		40			V
$V_{(\text{BR})\text{CBO}}$	Collector-Base Breakdown Voltage ($I_{\text{E}} = 0$)	$I_{\text{C}} = 10 \mu\text{A}$		60			V
$V_{(\text{BR})\text{EBO}}$	Emitter-Base Breakdown Voltage ($I_{\text{C}} = 0$)	$I_{\text{E}} = 10 \mu\text{A}$		6			V
$V_{\text{CE}(\text{sat})}^*$	Collector-Emitter Saturation Voltage	$I_{\text{C}} = 10 \text{ mA}$ $I_{\text{C}} = 50 \text{ mA}$	$I_{\text{B}} = 1 \text{ mA}$ $I_{\text{B}} = 5 \text{ mA}$			0.2 0.2	V V
$V_{\text{BE}(\text{sat})}^*$	Base-Emitter Saturation Voltage	$I_{\text{C}} = 10 \text{ mA}$ $I_{\text{C}} = 50 \text{ mA}$	$I_{\text{B}} = 1 \text{ mA}$ $I_{\text{B}} = 5 \text{ mA}$	0.65		0.85 0.95	V V
h_{FE}^*	DC Current Gain	$I_{\text{C}} = 0.1 \text{ mA}$ $I_{\text{C}} = 1 \text{ mA}$ $I_{\text{C}} = 10 \text{ mA}$ $I_{\text{C}} = 50 \text{ mA}$ $I_{\text{C}} = 100 \text{ mA}$	$V_{\text{CE}} = 1 \text{ V}$ $V_{\text{CE}} = 1 \text{ V}$ $V_{\text{CE}} = 1 \text{ V}$ $V_{\text{CE}} = 1 \text{ V}$ $V_{\text{CE}} = 1 \text{ V}$	60 80 100 60 30		300	
f_T	Transition Frequency	$I_{\text{C}} = 10 \text{ mA}$	$V_{\text{CE}} = 20 \text{ V}$	$f = 100 \text{ MHz}$	250	270	MHz
C_{CBO}	Collector-Base Capacitance	$I_{\text{E}} = 0$	$V_{\text{CB}} = 10 \text{ V}$	$f = 1 \text{ MHz}$		4	pF
C_{EBO}	Emitter-Base Capacitance	$I_{\text{C}} = 0$	$V_{\text{EB}} = 0.5 \text{ V}$	$f = 1 \text{ MHz}$		18	pF
NF	Noise Figure	$V_{\text{CE}} = 5 \text{ V}$	$I_{\text{C}} = 0.1 \text{ mA}$	$f = 10 \text{ Hz}$ to 15.7 KHz		5	dB
t_d t_r	Delay Time Rise Time	$I_{\text{C}} = 10 \text{ mA}$	$V_{\text{CC}} = 30 \text{ V}$	$I_{\text{B}} = 1 \text{ mA}$		35 35	ns ns
t_s t_f	Storage Time Fall Time	$I_{\text{C}} = 10 \text{ mA}$	$V_{\text{CC}} = 30 \text{ V}$	$I_{\text{B}1} = -I_{\text{B}2} = 1 \text{ mA}$		200 50	ns ns

* Pulsed: Pulse duration = 300 μs , duty cycle $\leq 2\%$

SOT-223 MECHANICAL DATA						
DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.80			0.071
B	0.60	0.70	0.80	0.024	0.027	0.031
B1	2.90	3.00	3.10	0.114	0.118	0.122
c	0.24	0.26	0.32	0.009	0.010	0.013
D	6.30	6.50	6.70	0.248	0.256	0.264
e		2.30			0.090	
e1		4.60			0.181	
E	3.30	3.50	3.70	0.130	0.138	0.146
H	6.70	7.00	7.30	0.264	0.276	0.287
V			10°			10°
A1		0.02				



P008B

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